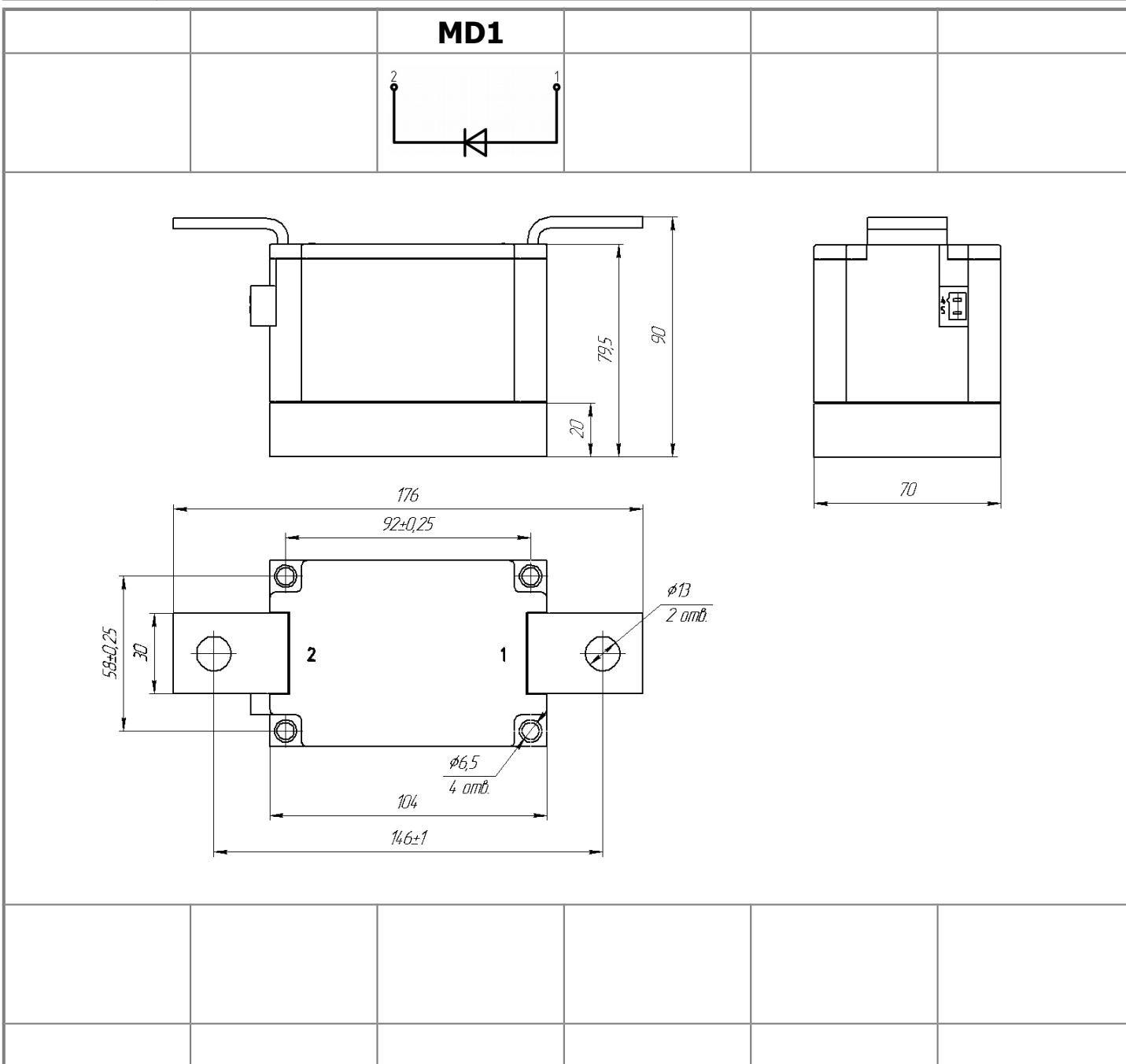




Electrically isolated base plate
Industrial standard package
Simplified mechanical design, rapid assembly
Pressure contact

**Single Diode Module
For Phase Control
MD1-950-44-E**

Average forward current	I _{FAV}	950 A
Repetitive peak reverse voltage	V _{RRM}	4000 ÷ 4400 V
V _{RRM} , V	4000	4200
Voltage code	40	42
T _j , °C	- 40 ÷ 160	44



All dimensions in millimeters (inches)

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I _{FAV}	Average forward current	A	950	T _c = 100 °C; 180° half-sine wave; 50 Hz	
I _{FRMS}	RMS forward current	A	1491	T _c = 100 °C; 180° half-sine wave; 50 Hz	
I _{FSM}	Surge forward current	kA	34.0 40.8	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _R =0 V;
			35.7 42.8	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _R =0 V;
I ² t	Safety factor	A ² s·10 ³	5780 8323	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _R =0 V;
			5289 7616	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _R =0 V;

BLOCKING

V _{RRM}	Repetitive peak reverse voltages	V	4000÷4400	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; 50 Hz;
V _{RSM}	Non-repetitive peak reverse voltages	V	4100÷4500	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; single pulse;
V _R	Reverse continuous voltages	V	0.75·V _{RRM}	T _j =T _j max;

THERMAL

T _{stg}	Storage temperature	°C	- 40 ÷ 50	
T _j	Operating junction temperature	°C	- 40 ÷ 160	

MECHANICAL

a	Acceleration under vibration	m/s ²	50	
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CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
ON-STATE				
V _{FM}	Peak forward voltage, max	V	1.50	T _j =25 °C; I _{FM} = 2512 A
V _{F(TO)}	Forward threshold voltage, max	V	0.80	T _j =T _j max;
r _T	Forward slope resistance, max	mΩ	0.270	0.5 π I _{FAV} < I _T < 1.5 π I _{FAV}
BLOCKING				
I _{RRM}	Repetitive peak reverse current, max	mA	100	T _j =T _j max; V _R =V _{RRM}
SWITCHING				
Q _{rr}	Total recovered charge, max	µC	5500	
t _{rr}	Reverse recovery time, max	µs	70	T _j =T _j max; I _{FM} =I _{FAV} ;
I _{rrM}	Peak reverse recovery current, max	A	157	dI _{FM} /dt=-5 A/µs; V _R =100 V
THERMAL				
R _{thjc}	Thermal resistance, junction to case			
	per module	°C/W	0.0420	
R _{thch}	Thermal resistance, case to heatsink			180° half-sine wave, 50 Hz
	per module	°C/W	0.0100	
INSULATION				
V _{ISOL}	Insulation test voltage	kV	3.00	Sine wave, 50 Hz; t=1 min
			3.60	RMS t=1 sec
MECHANICAL				
M ₁	Mounting torque (M6) ¹⁾	Nm	6.00	Tolerance ± 15%
M ₂	Terminal connection torque (M12) ¹⁾	Nm	18.00	Tolerance ± 15%
w	Weight	g	2550	

PART NUMBERING GUIDE								NOTES
MD 1 - 950 - 44 - E - N 1 2 3 4 5 6								1) The screws must be lubricated
1. MD - Rectifier Diode 2. Circuit Schematic 3. Average Forward Current, A 4. Voltage Code 5. Package Type (M.E) 6. Ambient Conditions: N – Normal								



UL certified file-No. E255404

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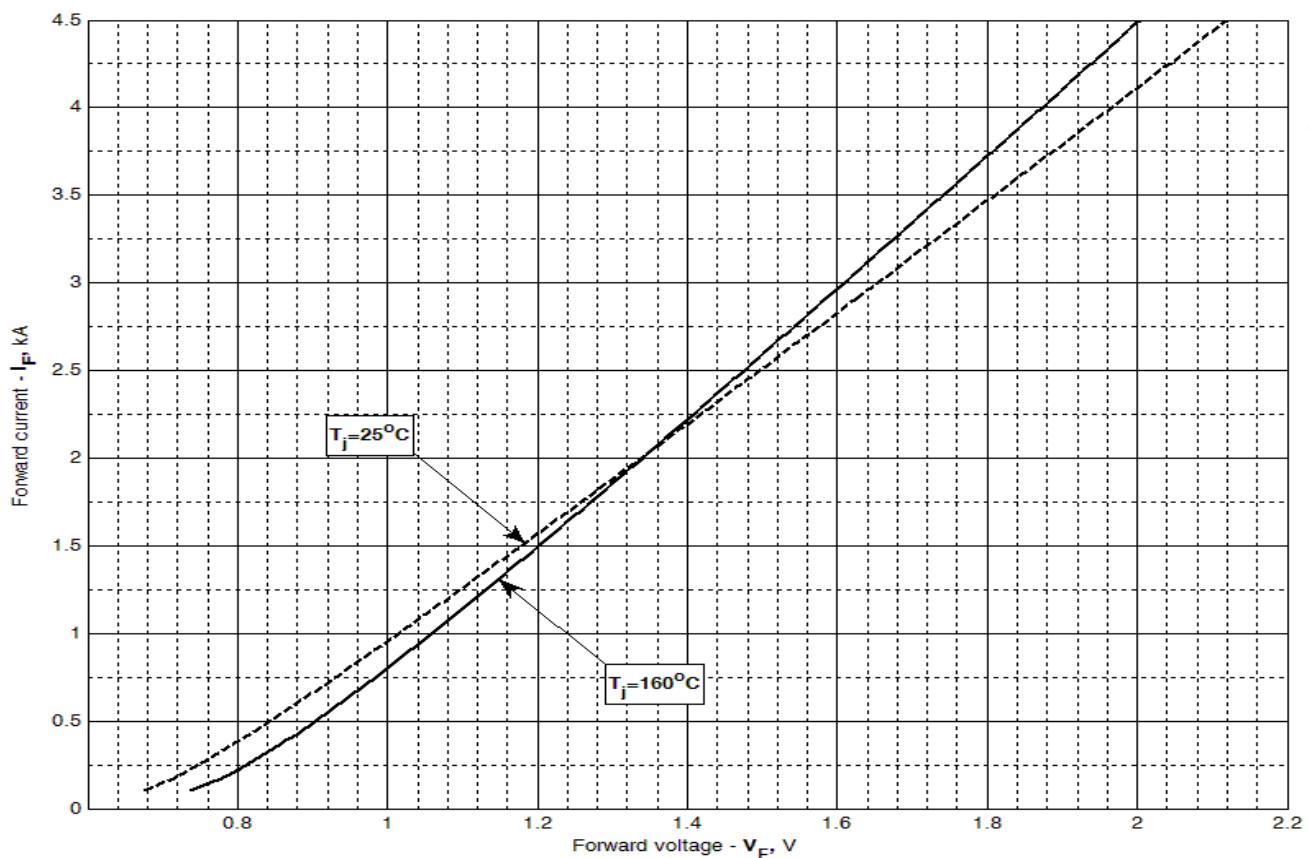


Fig 1 – Forward characteristics of Limit device

Analytical function for Forward characteristic:

$$V_F = A + B \cdot i_F + C \cdot \ln(i_F + 1) + D \cdot \sqrt{i_F}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j,\max}$
A	0.579461	0.615440
B	0.274124	0.209316
C	-0.148778	-0.216178
D	0.264245	0.383954

Forward characteristic model (see Fig. 1)

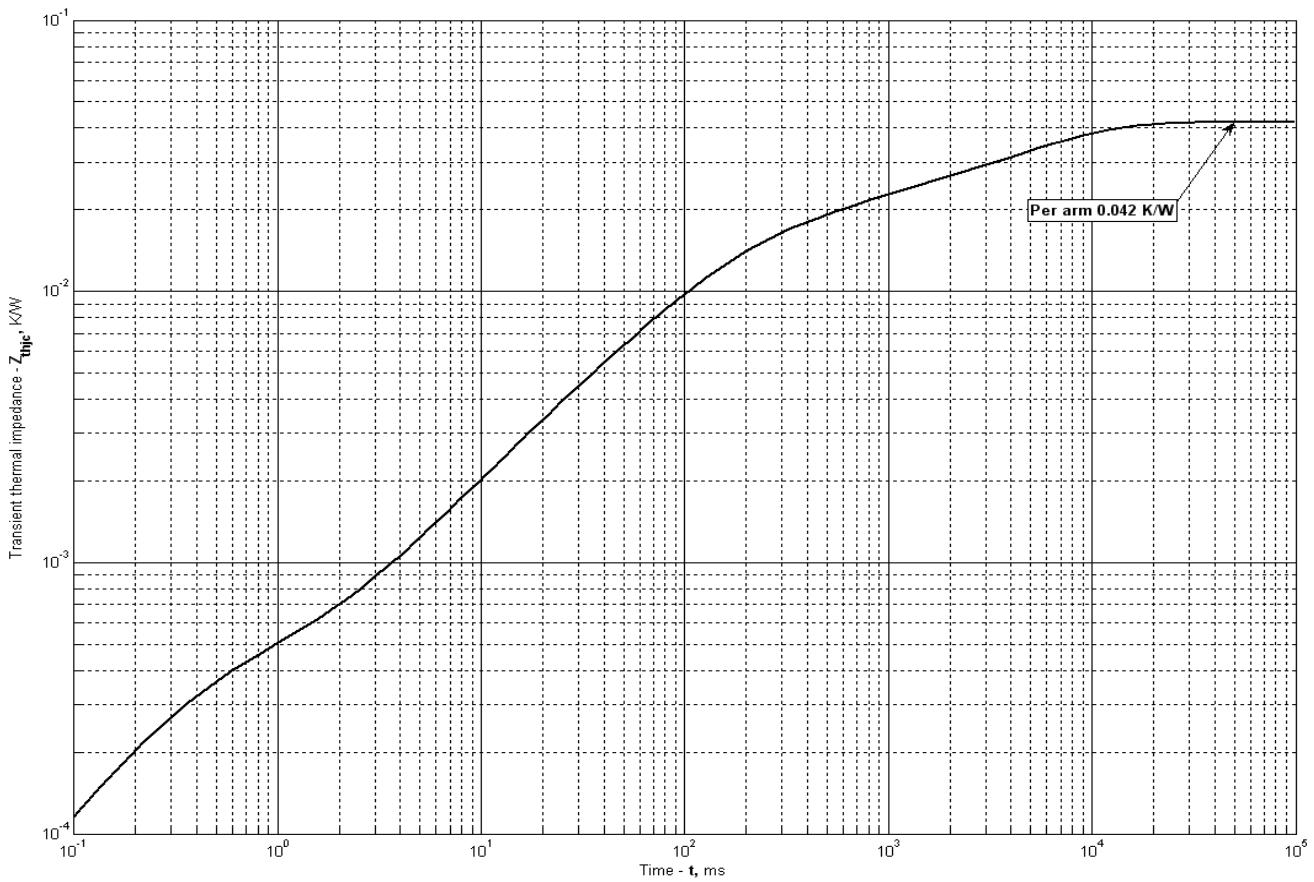


Fig 2 – Transient thermal impedance

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

i	1	2	3	4	5	6
R_i , K/W	0.02105	0.005931	0.009502	0.004252	0.001006	0.0003132
τ_i , s	5.887	0.7389	0.1616	0.08215	0.01267	0.0002712

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

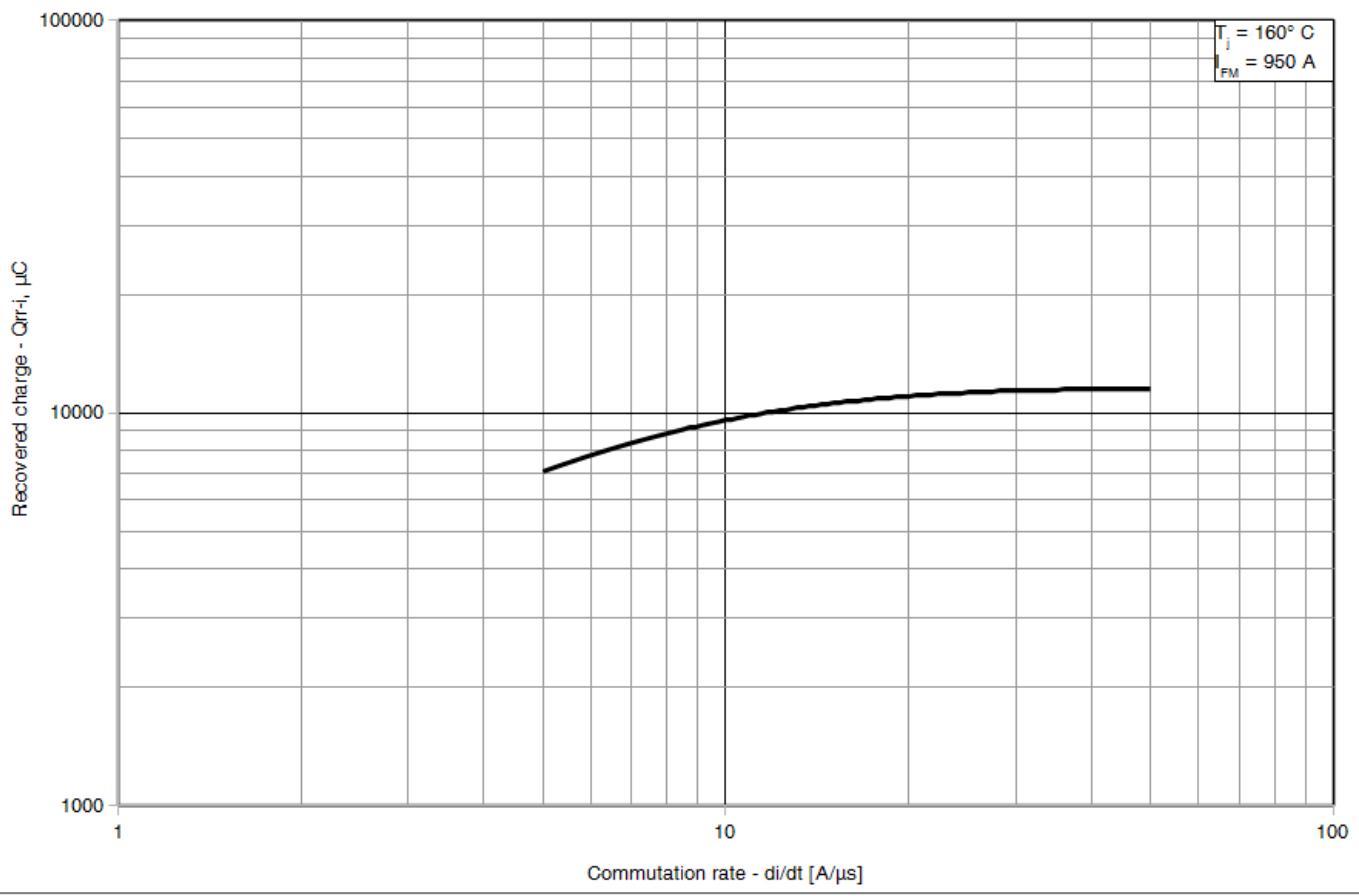


Fig 3 – Total recovered charge, Q_{rr-i} (integral)

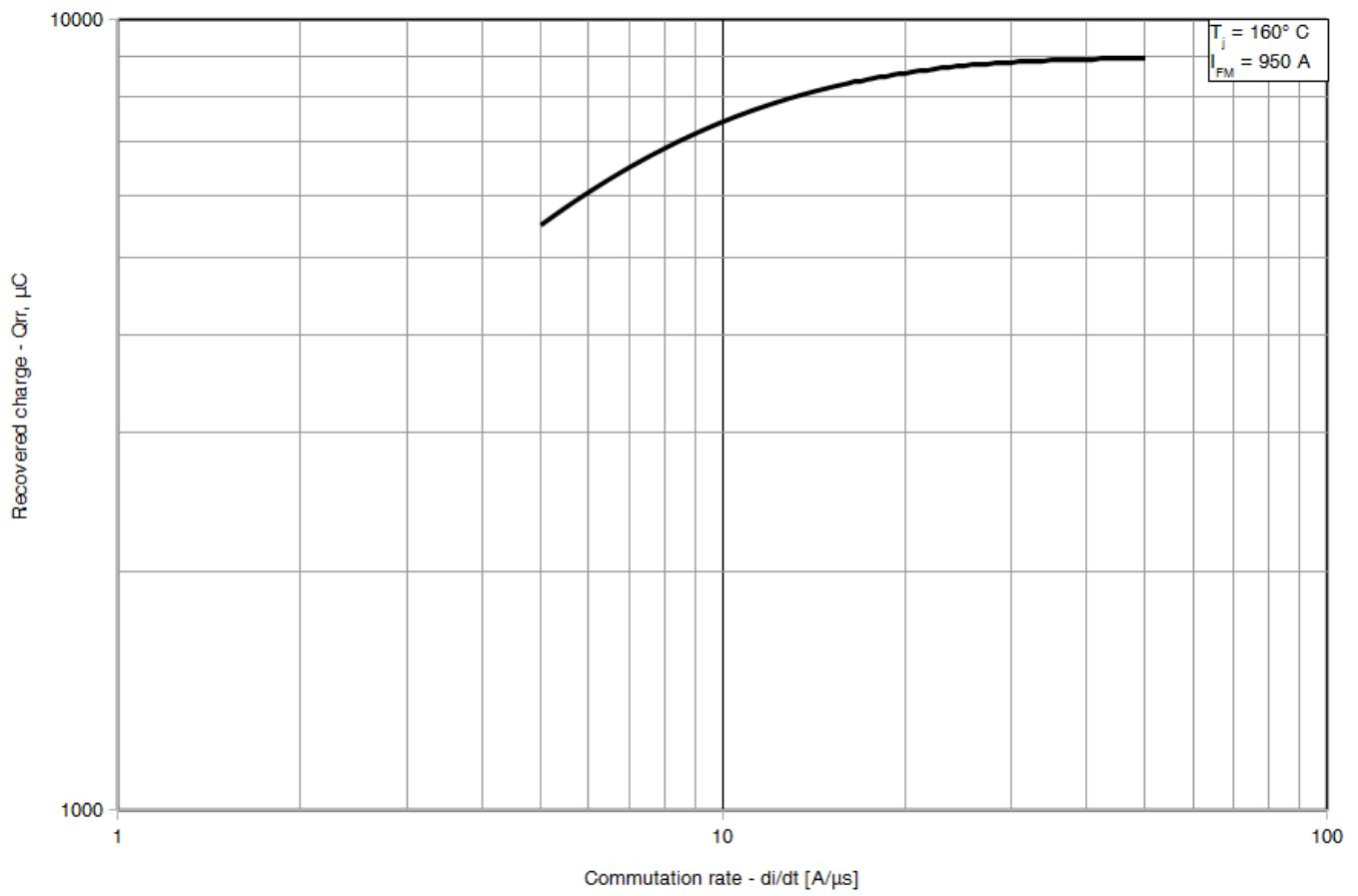


Fig 4 - Recovered charge, Q_{rr} (25% chord)

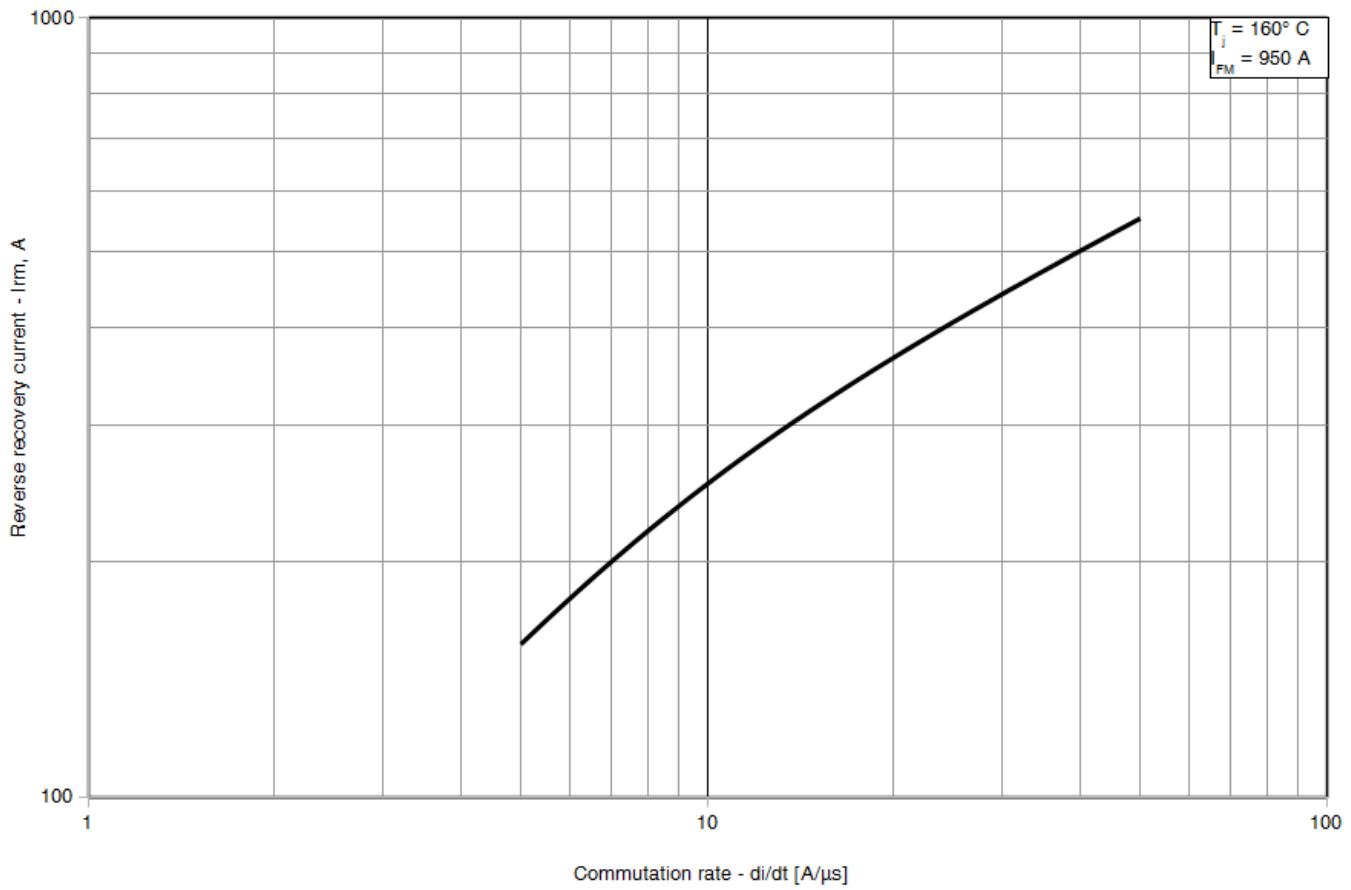


Fig 5 – Peak reverse recovery current, I_{rm}

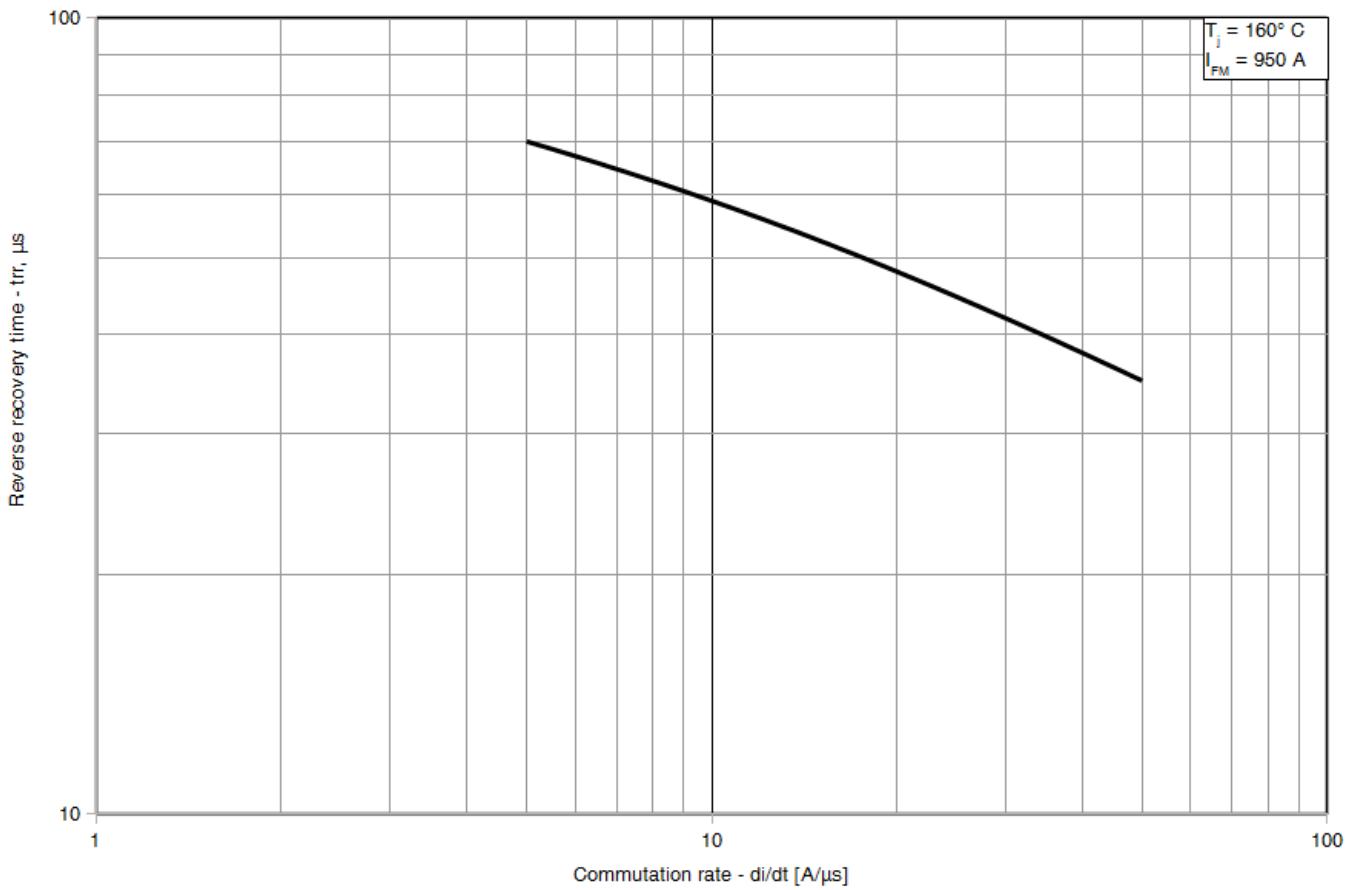


Fig 6 – Maximum recovery time, t_{rr} (25% chord)

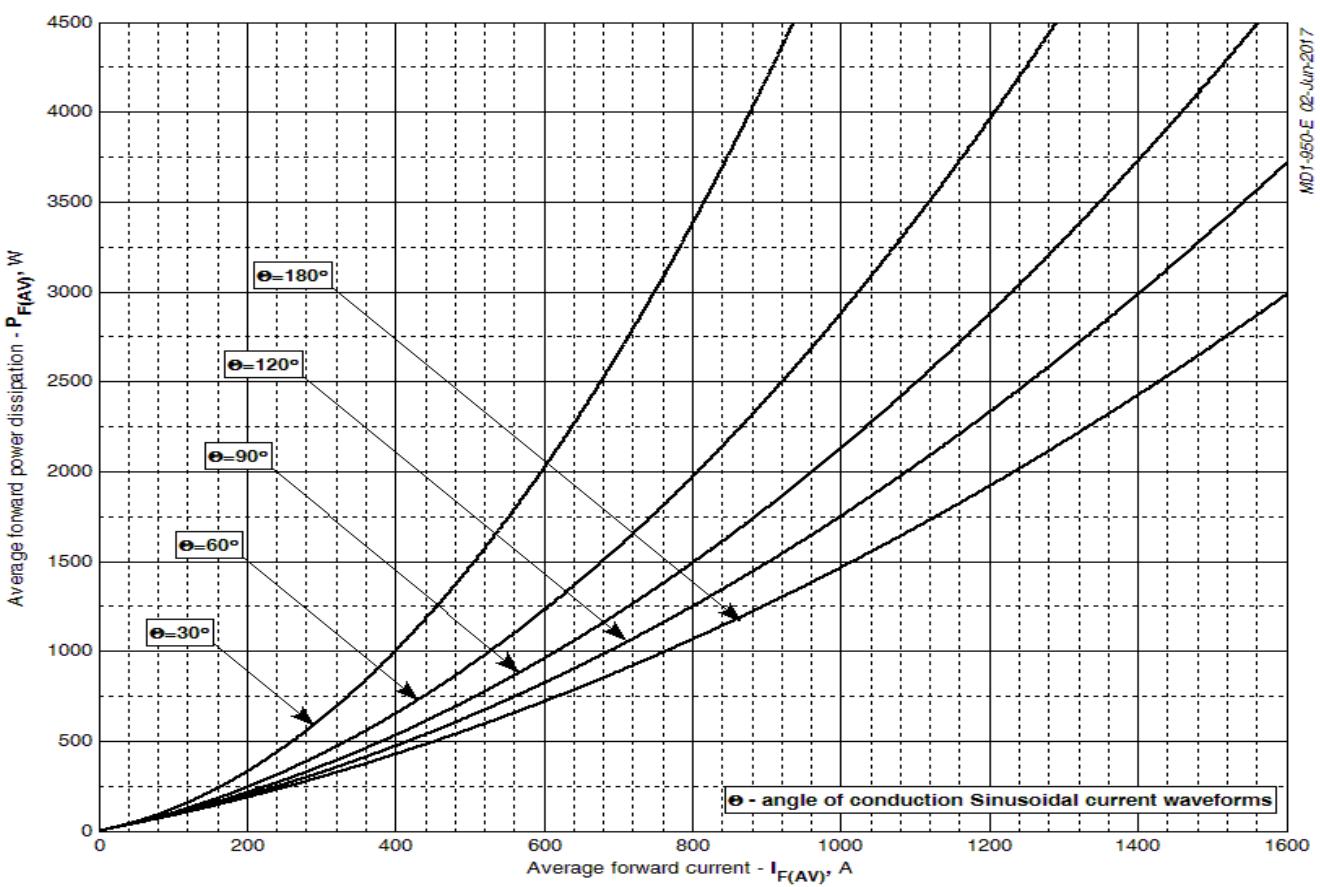


Fig 7 – Mean forward power dissipation $P_{FA(V)}$ vs. Mean forward current $I_{FA(V)}$ for sinusoidal current waveforms at different conduction angles

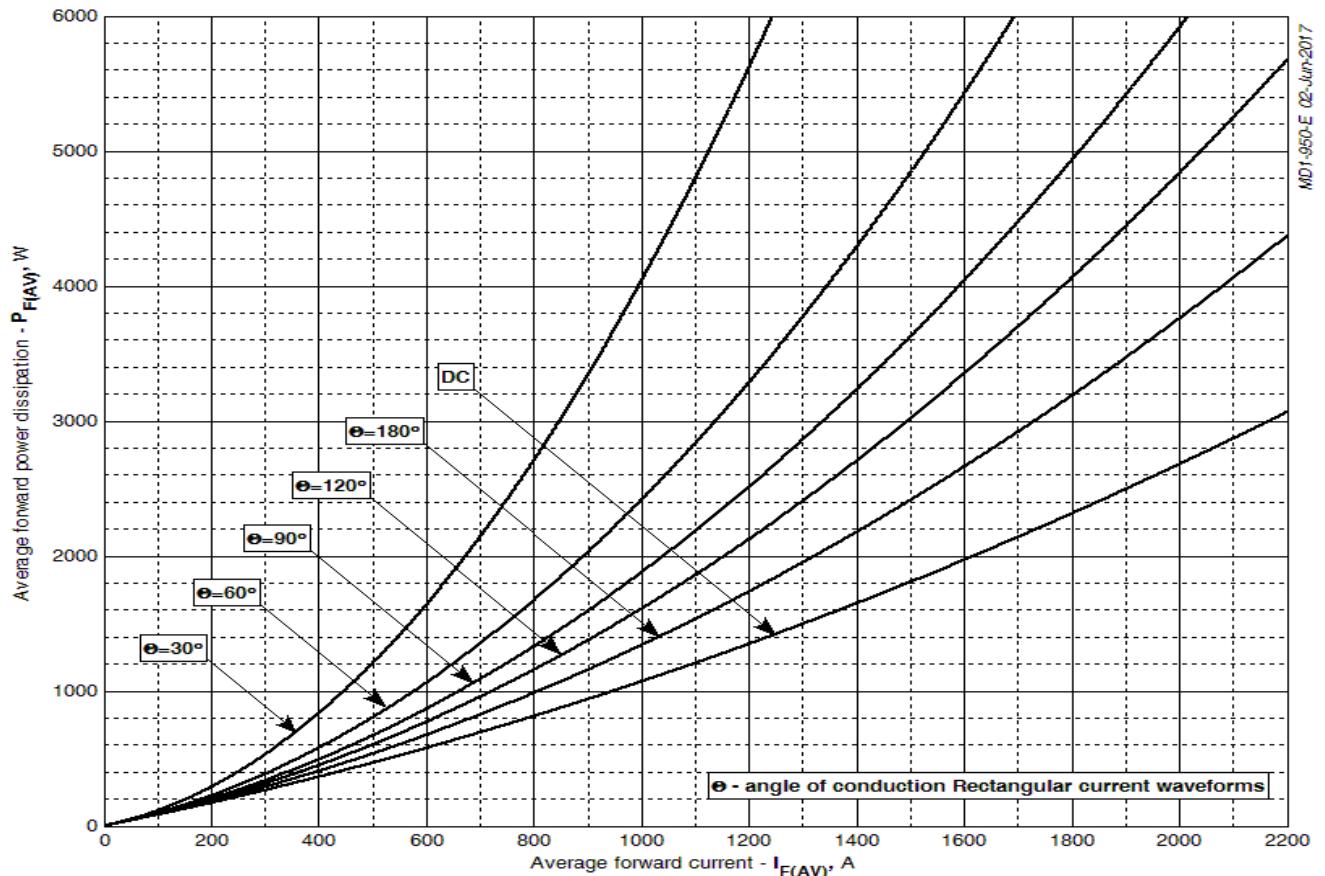


Fig 8 – Mean forward power dissipation $P_{FA(V)}$ vs. Mean forward current $I_{FA(V)}$ for rectangular current waveforms at different conduction angles and for DC

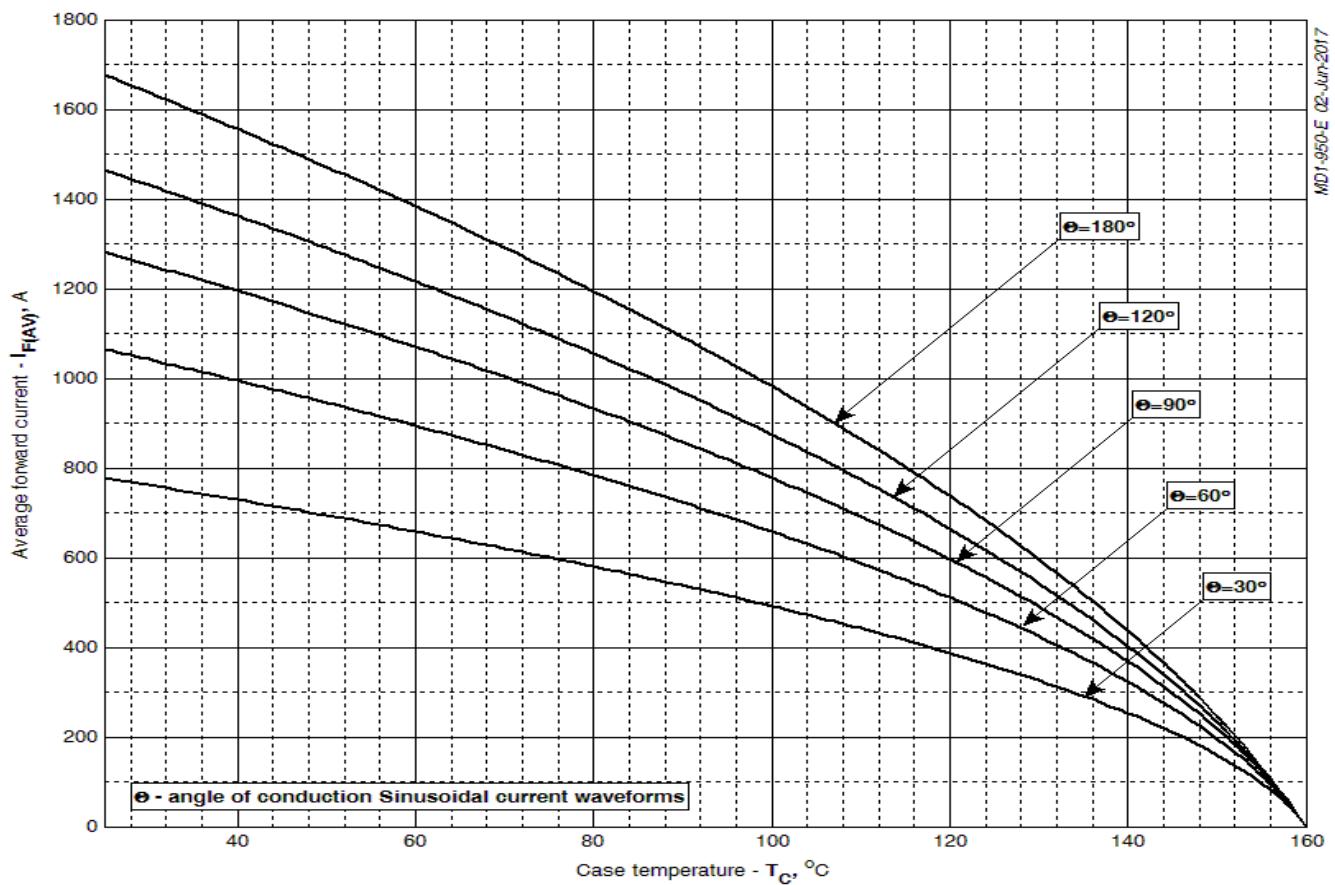


Fig 9 – Mean forward current I_{FAV} vs. Case temperature T_C for sinusoidal current waveforms at different conduction angles

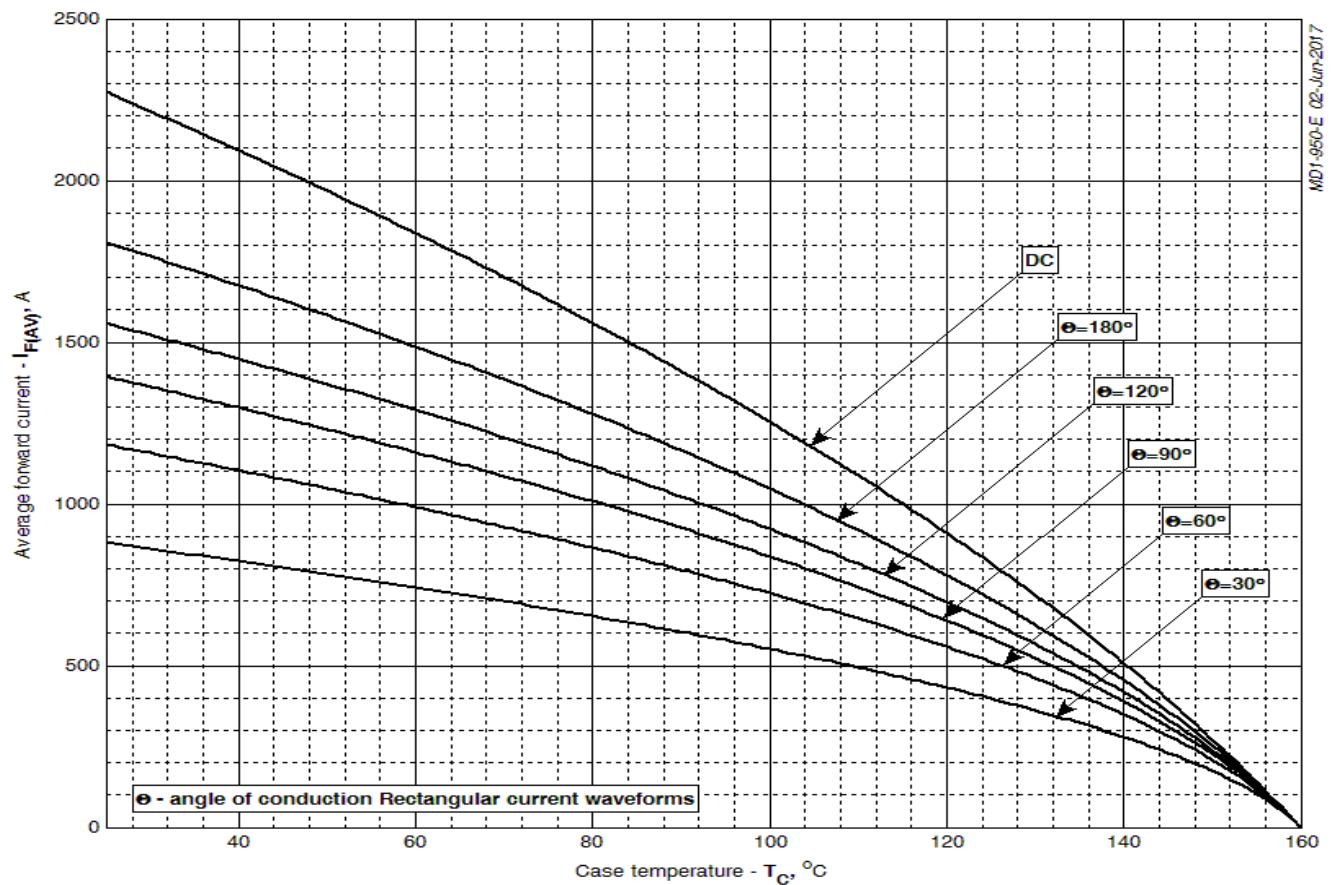


Fig 10 – Mean forward current I_{FAV} vs. Case temperature T_C for rectangular current waveforms at different conduction angles and for DC

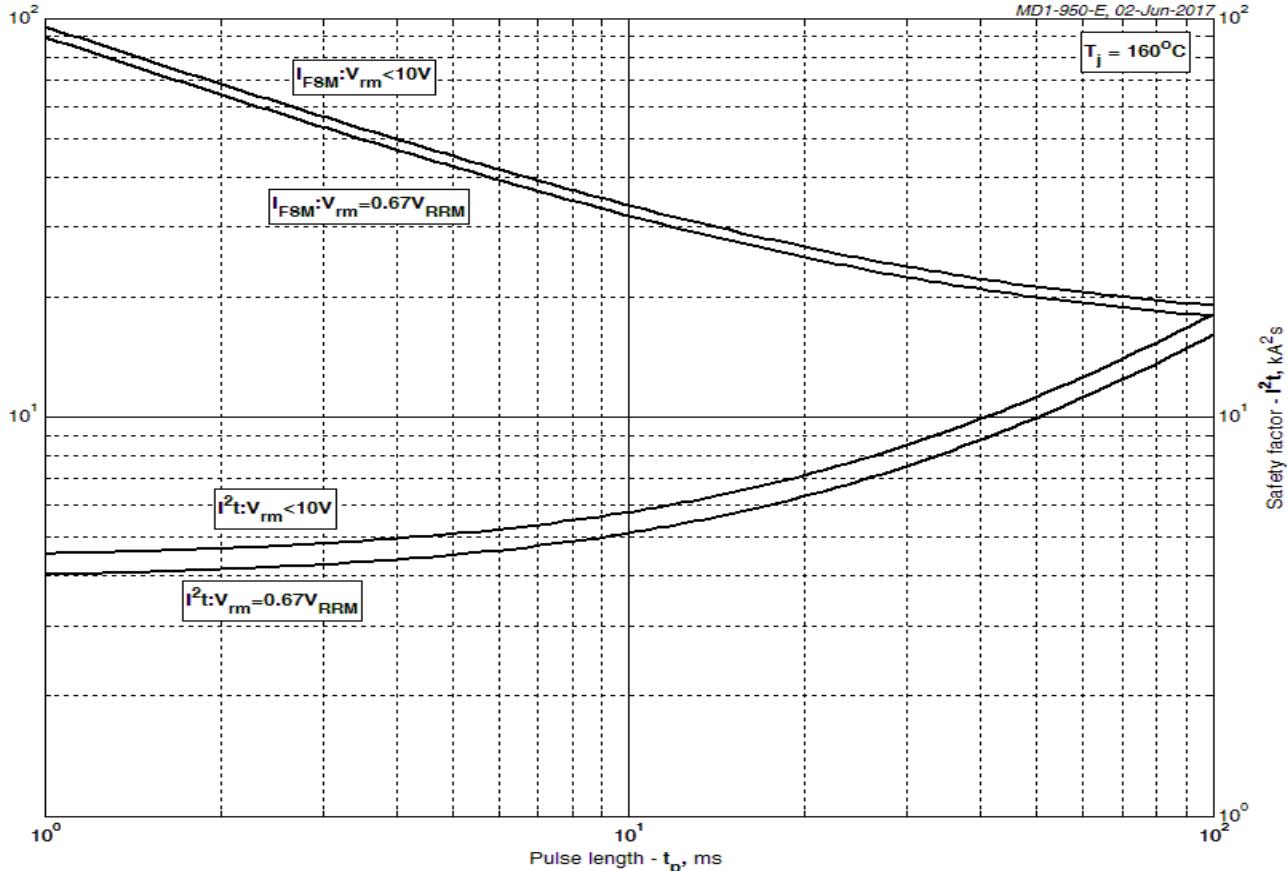


Fig 11 – Maximum surge and I^2t ratings

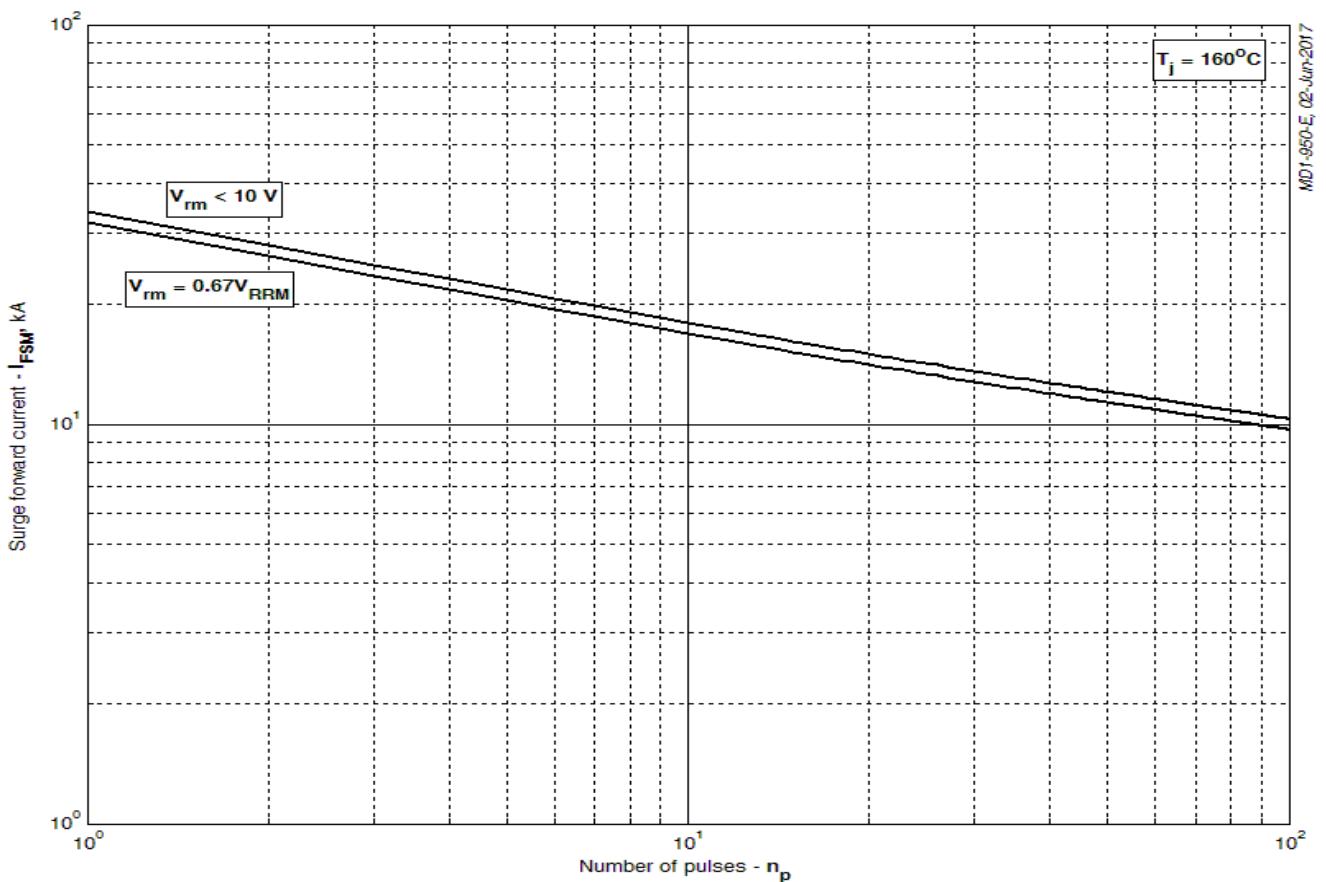


Fig 12 – Maximum surge ratings